

SURFACE MOUNT

RF Transformer

50Ω 10 to 1900 MHz

TC4-19LN+

FEATURES

- · Wideband, 10-1900 MHz
- Balanced transmission line with secondary center tap
- · Plastic base with leads
- Aqueous washable



Generic photo used for illustration purposes only

CASE STYLE: AT224-1A

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our website for methodologies and qualifications

APPLICATIONS

- PCS
- Cellular

ELECTRICAL SPECIFICATIONS AT +25°C

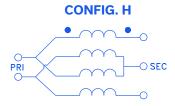
ELLOTRIOTE OF LOTTOROTT 123 C					
Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio (Secondary/Primary)			4		Ohm
Frequency Range		10		1900	MHz
	10-1900		3		
Insertion Loss*	20-1000		2		Deg.
	30-700		1		
Phase Unbalance	30-700		4		dB
Priase Oribalarice	20-1000		6		ив
Amenditural all lab along a	30-700		0.3		-ID
Amplitude Unbalance	20-1000		0.5		dB

 $^{^{\}star}$ Insertion Loss is referenced to mid-band loss, 1.0 dB typ

MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	150** mA

Permanent damage may occur if any of these limits are exceeded.



REV.B ECO-022263 TC4-19LN+ MCL NY 240628



 $^{^{\}star\star}$ Equal current applied through center tap to secondary dot & secondary, need DC blocking capacitors on primary dot & primary.



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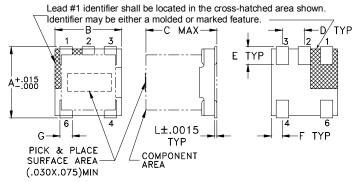
50Ω 10 to 1900 MHz

PIN CONNECTIONS

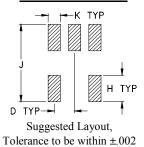
Function	Pin Number
PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	3
SECONDARY	1
SECONDARY CT	2

PRODUCT MARKING: N/A

OUTLINE DRAWING



PCB Land Pattern



OUTLINE DIMENSIONS (Inch)

F . 025 0.64	E . 040 1.02	D . 050 1.27	C .160 4.06	B . 150 3.81	A . 150 3.81
wt grams		.030	J .190	H .065	G .028
0.15		0.76	4 83	1 65	0.71

TAPE & REEL INFORMATION: F17



RF Transformer

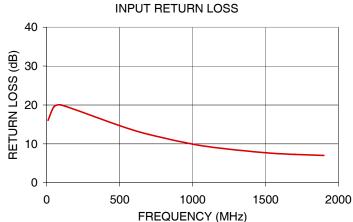
TC4-19LN+

50Ω 10 to 1900 MHz

TYPICAL PERFORMANCE DATA

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg.)
10.00	1.24	16.03	0.06	0.03
50.00	1.04	19.54	0.04	0.39
100.00	0.99	19.98	0.01	0.83
500.00	1.13	14.68	0.02	3.20
700.00	1.24	12.43	0.17	3.49
1000.00	1.55	9.92	0.49	3.74
1200.00	1.80	8.83	0.85	3.53
1500.00	2.34	7.69	1.47	3.59
1700.00	2.64	7.26	1.74	4.43
1900.00	2.99	7.01	1.95	4.99





NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



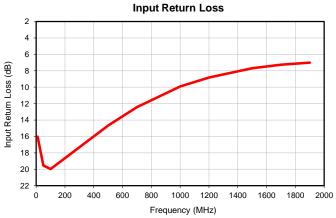
Typical Performance Data

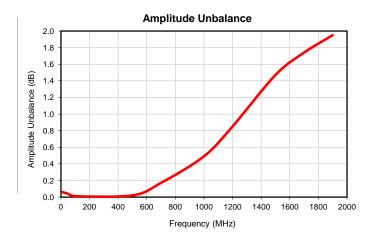
FREQUENCY (MHz)	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg.)
10.0	1.24	16.03	0.06	0.03
50.0	1.04	19.54	0.04	0.39
100.0	0.99	19.98	0.01	0.83
500.0	1.13	14.68	0.02	3.20
700.0	1.24	12.43	0.17	3.49
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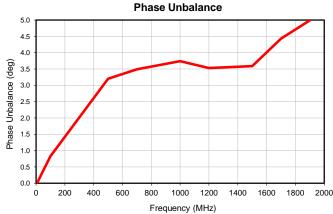


Typical Performance Data



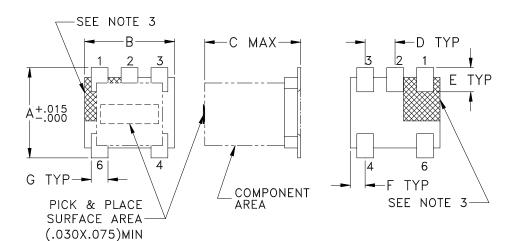




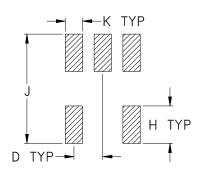


Outline Dimensions

AT224-1A



PCB Land Pattern



Suggested Layout, Tolerance to be within ±.002

CASE #	A	В	С	D	Е	F	G	Н	J	K	WT. GRAMS
AT224-1A	.150 (3.81)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

- 1. Case material: Plastic.
- 2. Termination finish:

For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.

3. Lead #1 identifier shall be located in the cross-hatched area shown. Identifier may be either a molded or marked feature.



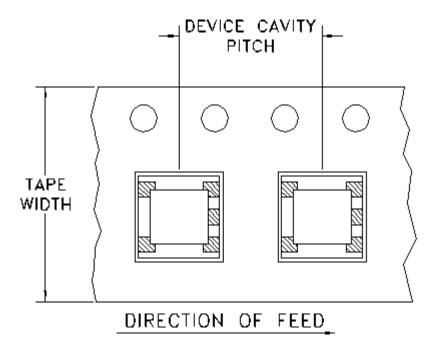


P.O. Box 350186, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices	s per Reel
			Small	20
			quantity	50
		7	standards	100
12	8		(see note)	200
				500
		12	Ctondond	1000
		13	Standard	2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf





P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS



Environmental Specifications

ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV02T1 Rev: B

02/25/11

M130240 File: ENV02T1.pdf

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